

EXHIBIT E

From: "Sheppard, Robert f" <sheppard@hp.com>
To: <Chad.Terrell@bakerbotts.com>
CC: <"Mehta, Boney">
Date: 1/21/2004 3:09 AM
Subject: RE: CLAM Patent Application (EDS 70-03-002; 014208.1635)

Chad,

These have been despatched today as requested.

Kind regards,

Robert F. Sheppard
EDS ITO UKIMEA
UK Service Enablement and Deployment
Architecture & Planning Group Central 3
Technical Support Team - Tools
Telephone +44 (0) 1952 230962
Mobile +44 (0) 7790495252
EMAIL robert.sheppard@eds.com

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-----Original Message-----

From: Chad.Terrell@bakerbotts.com [mailto:Chad.Terrell@bakerbotts.com]
Sent: 20 January 2004 01:04
To: robert.sheppard@eds.com
Subject: CLAM Patent Application (EDS 70-03-002; 014208.1635)

Robert,

Would you please send me an email confirming that you sent three original signed copies of the formal papers for the CLAM patent application by mail (or FedEx) yesterday, January 19, 2004? If so, I will go ahead and file the patent application with the U.S. Patent Office.

If you have any questions, please let me know.

Thanks,

Chad

Chad Terrell
BAKER BOTTS L.L.P.
2001 Ross Ave., 6th Floor
Dallas, Texas 75201-2980
(214) 953-6813 (office)
(214) 661-4813 (fax)
chad.terrell@bakerbotts.com
www.bakerbotts.com